

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

Detailed Change Description

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

► For NiPdAu-Plating lead frame

BOM	Current	Newly added
Adhesive	Ablestik 8900NC	Hitachi EN4300
Molding Compound	Hitachi CEL 9220HF13	Sumitomo G700LA

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

► For Ag-plating lead frame

BOM	Current	Newly added
Adhesive	Ablestik 8900NC	Hitachi EN4300
Molding Compound	Sumitomo G770	Sumitomo G700LA